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## LED DISPLAY DRIVER

## FEATURES SUMMARY

- 2 DIGIT LED DRIVER (14 segments)
- CURRENT GENERATOR OUTPUTS (no registor required)
- CONTINUOUS BRIGHTNESS CONTROL
- SERIAL DATA INPUT
- DATA ENABLE
- WIDE SUPPLY VOLTAGE OPERATION
- TLL COMPATIBILITY
- APPLICATION EXAMPLES
- MICROPROCESSOR DISPLAYS
- INDUSTRIAL CONTROL INDICATOR
- RELAY DRIVER
- INSTRUMENTATION READOUTS


## DESCRIPTION

The M5481 is a monolithic MOS integrated circuit produced with a N -channel silicon gate technology. It uses the M5450 die packaged in a « 1 -pin plastic package copper frame, making i' incal ior a 1-digit display. A single pin controls t'e I-ED display brightness by setting a $r \in f$ rence current
through a variable resistor connected either to $V_{D D}$ or to a separate supply of 13.2 V maximum.
The M5481 is a pin-to-pin replacement of the NS MM 5481.

Figure 1. Package


Figure 2. Pin Connent'ins


REV. 2

Figure 3. Block Diagram


Table 1. Absolute Maximum Ratings

| Symbol | Parameter | Value | Unit |
| :---: | :--- | :---: | :---: |
| $\mathrm{V}_{\mathrm{DD}}$ | Supply Voltage | -0.3 to 15 | V |
| $\mathrm{~V}_{\mathrm{I}}$ | Input Voltage | -0.3 to 15 | V |
| $\mathrm{~V}_{\text {O(off) }}$ | Off State Output Voltage | 15 | V |
| $\mathrm{IO}_{\mathrm{O}}$ | Output Sink Current | 40 | mA |
| $\mathrm{P}_{\text {TOT }}$ | Total Package Power Dissipation at $25^{\circ} \mathrm{C}$ | 1.5 | W |
|  | Total Package Power Dissipation at $85^{\circ} \mathrm{C}$ | 800 | mW |
| $\mathrm{~T}_{\mathrm{j}}$ | Junction Temperature | 150 | ${ }^{\circ} \mathrm{C}$ |
| TOP | Operating Temperature Range | -25 to 85 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{T}_{\text {STG }}$ | Storage Temperature Range | -65 to 150 | ${ }^{\circ} \mathrm{C}$ |

Note: Stresses exceeding those listed under "Absolute Maximum Ratings" may cause permanent damage to the device and affect its reliability.

Table 2. Static Electrical Characteristics
( $T_{\text {amb }}$ within operating range, $\mathrm{V}_{\mathrm{DD}}=4.75 \mathrm{~V}$ to $13.2 \mathrm{~V}, \mathrm{~V}_{\mathrm{SS}}=0 \mathrm{~V}$, unless otherwise specified)

| Symbol | Parameter | Test Conditions | Min. | Typ. | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{\text {DD }}$ | Supply Voltage |  | 4.5 |  | 13.2 | V |
| IDD | Supply Current | $\mathrm{V}_{\mathrm{DD}}=13.2 \mathrm{~V}$ |  |  | 7 | mA |
| $\mathrm{V}_{1}$ | Input Voltage Logical "0" Level Logical "1" Level | $\begin{aligned} & \pm 10 \mu \mathrm{~A} \text { Input Bias } \\ & 4.75 \leq \mathrm{V}_{\mathrm{DD}} \leq 5.25 \\ & \mathrm{~V}_{\mathrm{DD}}>5.25 \end{aligned}$ | $\begin{gathered} -0.3 \\ 2.2 \\ V_{D D}-2 \end{gathered}$ |  | $\begin{gathered} \hline 0.8 \\ V_{D D} \\ V_{D D} \end{gathered}$ | $\begin{aligned} & \hline \mathrm{V} \\ & \mathrm{~V} \\ & \mathrm{~V} \end{aligned}$ |
| IB | Brightness Input Current (note 2) |  | 0 |  | 0.75 | mA |
| $\begin{gathered} \mathrm{V}_{\mathrm{B}} \\ \mathrm{~V}_{\mathrm{O}(\text { off })} \end{gathered}$ | Brightness Input Voltage (pin 9) Off State Out. Voltage | Input Current $=750 \mu \mathrm{~A}, \mathrm{~T}_{\mathrm{amb}}=25^{\circ} \mathrm{C}$ | 3 |  | $\begin{aligned} & \hline 4.3 \\ & 13.2 \end{aligned}$ | $\mathrm{V}_{\mathrm{V}}$ |
| lo | Out. Sink Current (note 3) <br> Segment OFF <br> Segment ON | $\begin{aligned} & \mathrm{V}_{\mathrm{O}}=3 \mathrm{~V} \\ & \mathrm{~V}_{\mathrm{O}}=1 \mathrm{~V}(\text { note } 4) \\ & \text { Brightness } \operatorname{In} .=0 \mu \mathrm{~A} \\ & \text { Brightness } \operatorname{In} .=100 \mu \mathrm{~A} \\ & \text { Brightness } \operatorname{In} .=750 \mu \mathrm{~A} \end{aligned}$ | $\begin{gathered} 0 \\ 2 \\ 12 \end{gathered}$ | $\begin{gathered} 2,7 \\ 15 \end{gathered}$ | $\begin{gathered} 10 \\ \\ 10 \\ 4 \\ 25 \end{gathered}$ | $\mu \mathrm{A}$ <br> $\mu \mathrm{A}$ <br> mA <br> mA |
| $\mathrm{f}_{\text {clock }}$ | Input Clock Frequency |  | 0 |  | 0.5 | MHz |
| Io | Output Matching (note 1) |  |  |  | $\pm 20$ | \% |

Note: 1. Output matching is calculated as the percent variation from $I_{\mathrm{MAX}}+I_{\mathrm{MIN}} / 2$.
2. With a fixed resistor on the brightness input some variation in brightness will occur from one device to another.
3. Absolute maximum for each output should be limited to 40 mA .
4. The $\mathrm{V}_{\mathrm{O}}$ voltage should be regulated by the user.

## FUNCTIONAL DESCRIPTION

The M5481 uses the M5450 die which is packaged to operate 2 -digit alphanumeric displays with minimal interface with the display and the data source. Serial data transfer from the data source to the display driver is accomplished with 2 signals, serial data and clock. using a format of a leading "1" followed by the 35 data bits allows data transfer without an additional load signal.
The 35 data bits are latched after the 36th bit is complete, thus providing non-multiplexed, direct drive to the display. Outputs change only if the serial data bits differ from the previous time. Display brightness is determined by control of the output current for LED displays. A 1 nF capacitor should
be connected to brightness control (pin 9) to prevent possible oscillations.
A block diagram is shown on Figure 3. The output current is typically 20 times greater than the current into pin 9 , which is set by an external variable resistor.
The latter is an internal limiting resistor of $400 \Omega$ nominal value.
Figure 4 shows the input data format. A start bit of logical " 1 " precedes the 35 bits of data. At the 36th clock a LOAD is generated synchronously with the high state of the clock, which loads the 35 bits of the shift registers into the latches.

Figure 4. Input Data Format


At the low state of the clock a RESET signal is generated which clears all the shift registers for the next set of data. The shift registers are static master slave configurations. There is no clear for the master portion of the first shift register, thus allowing continuous operation.
There must be a complete set of 36 clocks or the shift registers will not clear.
When power is first applied to the chip an internal power ON reset signal is generated which resets all registers and all latches. The START bit and the first clock reset the chip to its normal operation.
Figure 5 shows the timing relationships between Data, Clock and DATA ENABLE.
A maximum clock frequency of 0.5 MHz is assumed.
Table 3 shows the Output Data Format for the M5481. Because it uses only 14 of the possible outputs, 21 of the bits (including bit 35 which was already unused in the M5450) are "Don't Cares" .
For applications where a lesser number of outputs are used it is possible to either increase the current per output or operate the part at higher than $1 \mathrm{~V} V_{\text {out }}$.
The following equation can be used for calculations.
$\mathrm{T}_{\mathrm{j}}=\left[\left(\mathrm{V}_{\text {out }}\right)\left(\mathrm{l}_{\text {LED }}\right)(\right.$ No. of segments $\left.)+\mathrm{V}_{\mathrm{DD}} \times 7 \mathrm{~mA}\right]$ $x\left(80^{\circ} \mathrm{C} / \mathrm{W}\right)+\mathrm{T}_{\mathrm{amb}}$
where:
$\mathrm{T}_{\mathrm{j}}=$ junction temperature $\left(150^{\circ} \mathrm{Cmax}\right)$
$\mathrm{V}_{\text {out }}=$ voltage at the LED driver outputs
lLED = LED current
$80^{\circ} \mathrm{C} / \mathrm{W}=$ thermal coefficient of the package
$\mathrm{T}_{\mathrm{amb}}=$ ambiant temperature

Figure 5.


Table 3. Serial Data Bus / Outputs Correspondance

| 5451 | 35 | 34 | 33 | 32 | 31 | 30 | 29 | 28 | 27 | 26 | 25 | 24 | 23 | 22 | 21 | 20 | 19 | 18 | START |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 5481 | X | X | X | X | X | 14 | 13 | X | X | X | X | 12 | 11 | 10 | 9 | X | X | X | START |
| $\mathbf{5 4 5 0}$ | 17 | 16 | 15 | 14 | 13 | 12 | 11 | 10 | 9 | 8 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | START |  |
| 5481 | X | 8 | 7 | 6 | 5 | X | X | X | X | 4 | 3 | 2 | 1 | X | X | X | X | START |  |

## TYPICAL APPLICATION

Figure 6. BASIC electronically tuned TV system


## POWER DISSIPATION OF THE IC

The power dissipation of the IC can be limited using different configurations.

Figure 7.


In this application R must be chosen taking into account the worst operating conditions.
$R$ is determined by the maximum number of segments activated.

$$
R=\frac{v_{C}-v_{\text {DMAX }}-v_{\text {OMIN }}}{N_{\text {MAX }}{ }^{L_{D}}}
$$

The worst case condition for the device is when roughly half of the maximum number of segments are activated.
It must be checked that the total power dissipation does not exceed the absolute maximum ratings of the device.
In critical cases more resistors can be used in conjunction with groups of segments. In this case the current variation in the single resistor is reduced and $P_{\text {tot }}$ limited.

Figure 8.


In this configuration the drop on the serial connected diodes is quite stable if the diodes are properly chosen.
The total power dissipation of the IC depends only, in first approximation, on the number of segments activated.

Figure 9.


In this configuration $\mathrm{V}_{\mathrm{OUT}}+\mathrm{V}_{\mathrm{D}}$ is constant. the total power dissipation of the IC depends only on the number of segments activated.

## PART NUMBERING

Table 4. Order Codes

| Part Number | Package | Temperature Range |
| :---: | :---: | :---: |
| M5481 B7 | PDIP | -25 to $85^{\circ} \mathrm{C}$ |

## M5481

## PACKAGE MECHANICAL

Table 5. PDIP20 - Mechanical Data

| Symbol | millimeters |  |  | inches |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | Typ | Min | Max | Typ | Min | Max |
| A | 3.25 | 3.30 | 3.35 | 0.128 | 0.130 | 0.132 |
| a1 |  | 0.508 |  |  | 0.020 |  |
| B | 1.39 |  | 1.65 | 0.055 |  | 0.065 |
| b | 0.381 | 0.457 | 0.533 | 0.015 | 0.018 | 0.021 |
| b1 | 0.20 | 0.254 | 0.30 | 0.008 | 0.010 | 0.012 |
| C | 5.20 | 5.33 | 5.46 | 0.205 | 0.210 | 0.215 |
| D | 24.9 | 25.15 | 25.4 | 0.980 | 0.990 | 1.000 |
| E | 7.8 | 8.5 | 9.1 | 0.307 | 0.335 | 0.358 |
| e | 2.29 | 2.54 | 2.79 | 0.090 | 0.100 | 0.110 |
| e3 | 22.60 | 22.86 | 23.11 | 0.890 | 0.900 | 0.910 |
| e4 | 7.36 | 7.62 | 7.87 | 0.290 | 0.300 | 0.310 |
| F | 6.22 | 6.35 | 6.50 | 0.245 | 0.250 | 0.255 |
| I | 3.42 | 3.68 | 3.93 | 0.135 | 0.145 | 0.155 |
| L | 3.17 | 3.30 | 3.42 | 0.125 | 0.130 | 0.135 |
| N |  | 7 d |  |  | 7 d |  |
| R1 |  | 0.152 |  |  | 0.006 |  |
| R2 |  | 0.762 |  |  | 0.030 |  |
| K |  | 1.524 |  |  | 0.060 |  |
| K1 |  | 0.762 |  |  | 0.030 |  |
| K2 |  | 0.762 |  |  | 0.030 |  |
| Z |  | 1.27 | 1.34 |  | 0.050 | 0.053 |

Figure 10. PDIP20 - Package Dimensions


Note: Drawing is not to scale

## REVISION HISTORY

Table 6. Revision History

| Date | Revision | Description of Changes |
| :---: | :---: | :--- |
| October-2000 | 1 | First Issue |
| 14-Apr-2004 | 2 | Stylesheet update. No content change. |

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